

## **Application Data Sheet**

### **APPLICATION INFORMATION**

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?:

Computer Readable From (CRF)?: No

Number of Copies of CRF::

Title:: AUTOMATIC CIRCUIT DESIGN APPARATUS  
AND COMPUTER-IMPLEMENTED AUTOMATIC  
CIRCUIT DESIGN METHOD

Attorney Docket Number:: 402924

Request for Early Publication?: No

Request for Non-Publication?: No

Suggested Drawing Figure::

Total Drawing Sheets:: 14

Small Entity?: No

Latin Name::

Variety denomination name::

Petition Included?: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?: No

## APPLICANT INFORMATION

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Representative Customer Number:: 23548

Representative Designation::                      Registration Number::                      Representative Name::

## **DOMESTIC PRIORITY INFORMATION**

Application::                      Continuity Type::                      Parent Application::                      Parent Filing Date::

## FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2002-381786	12/27/02	Yes

## ASSIGNEE INFORMATION

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